Measurements with SiPM-based Front-End Electronics FERS-5200

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- **Comparison of the results** with a complementary system based on charge integration acquisition.

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Front-End Structure

A5202 board

The A5202 [1] is an **all-in-one** front-end board optimized to work with **SiPM**.

- bias voltage provided by power supply embedded in the board
- event acquisition handled with ASIC Citiroc-1A [2]
- multiple trigger logic options onboard
- 64-ch on a single board, easily scalable up to 8 boards

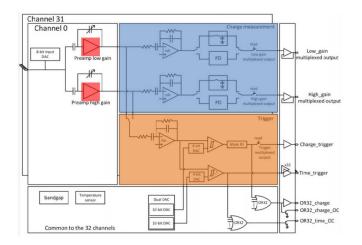


[1] https://www.caen.it/products/a5202/

[2] https://www.weeroc.com/my-weeroc/download-center/citiroc-1a/16-citiroc1a-datasheet-v2-5/file 🕨 < 🖹 🕨 🚊 🔗 🤆

Front-End Structure

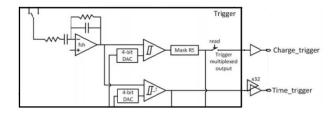
two preamplifiers connected to: charge measurement and trigger sections



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Front-End Structure: Trigger section

- Fast shaper amplifier: 15 ns peaking time, followed by:
 - Timing discriminator: its output is used for logical combination of the channels by the FPGA
 - Charge discriminator: output used for the charge circuit

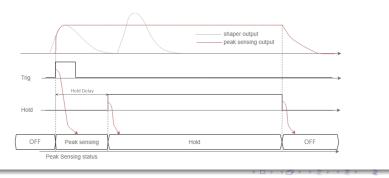


Front-End Structure: Charge section

- Two preamplication stages: high and low gain
- Slow shaper amplifier: shaping time range between 12.5 ns and 87.5 ns

Peak Detector Working Principle

Three sequentially phases:

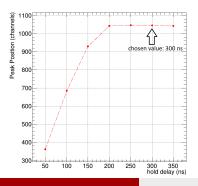


Event Selection

Hold delay:

Time difference between the bunch trigger and the arrival of the hold signal.

Crystal: LYSO



- Small values of hold delay lead to incorrect energy values.
- Correct values are in the plot flat region. We selected 300 ns.

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Set-up

Measurements have been taken with two types of SiPM:

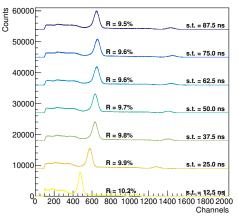
- A. 64 channels Hamamatsu SiPM matrix S13361-3050AE-08 (single cell dimensions: 3x3 mm²)
- B. LYSO matrix
- C. Hamamatsu SiPM MPPC S13360-6050CS (6x6 mm²)
- D. LYSO crystal (6x6x15 mm³)





Event Selection: Shaping Time

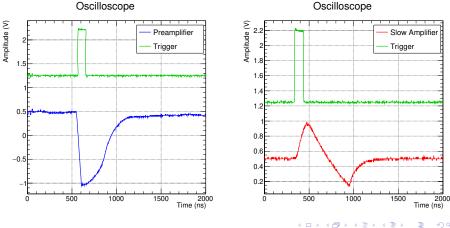
 ²²Na energy spectra for all the possible A5202 shaping times acquired with LYSO (SiPM 6x6 mm²).



LYSO

Event Selection: Oscilloscope

Analog and digital probes are available on the A5202 board to check that the event selection is correctly done.

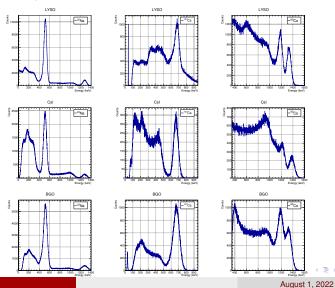


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Results

Results

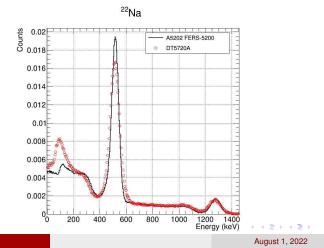
SiPM: 6x6 mm². Crystals: LYSO, Csl, BGO. Sources: ²²Na, ¹³⁷Cs, ⁶⁰Co



Control System

We took the same measurements with the DT5720A digitizer and with the same scintillators.

• digitizer method: charge integration



Results

Resolutions obtained so far

sources:	crystals:
● ²² Na	LYSO
● ¹³⁷ Cs	Csl
● ⁶⁰ Co	BGO

	22 Na (511 KeV)	$^{137}Cs~(662~{\rm KeV})$	60 Co (1172 KeV)	60 Co (1332 KeV)
A5202+LYSO	$(9.5 \pm 0.1)\%$	$(9.3 \pm 0.1)\%$	$(5.8 \pm 0.1)\%$	$(5.0 \pm 0.1)\%$
DT5720A+LYSO	$(12.3 \pm 0.1)\%$	$(10.3 \pm 0.1)\%$	$(6.3 \pm 0.4)\%$	$(5.4 \pm 0.2)\%$
A5202+CsI(Tl)	$(11.9 \pm 0.1)\%$	$(10.9 \pm 0.1)\%$	$(5.8 \pm 0.2)\%$	$(5.6 \pm 0.1)\%$
DT5720A+CsI(Tl)	$(9.6 \pm 0.1)\%$	(8.9 ± 0.1) %	$(5.6 \pm 0.2)\%$	$(5.4 \pm 0.1)\%$
A5202+BGO	$(14.4 \pm 0.1)\%$	$(13.5 \pm 0.1)\%$	$(8.7 \pm 0.1)\%$	$(7.1 \pm 0.1)\%$
DT5720A+BGO	$(12.0 \pm 0.1)\%$	$(11.0 \pm 0.1)\%$	$(7.7 \pm 0.3)\%$	$(6.8 \pm 0.4)\%$

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- We have found that the dimensions of the SiPM active area directly determines whether the system is able or not to perform energy resolution measurements and to build the energy spectra

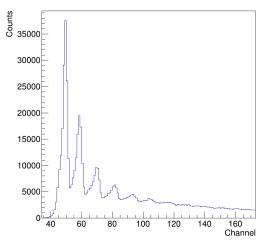
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- We have found that the dimensions of the SiPM active area directly determines whether the system is able or not to perform energy resolution measurements and to build the energy spectra
- We plan on taking measurements even with **faster scintillators** like Lathanum Bromine and to perform **timing resolution measurements**.

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Back-Up

Single Photon spectrum

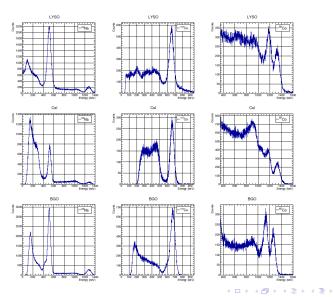


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Back-Up- DT5720A spectra



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Back-up: SiPM Matrix

Structure

Parameter	Symbol	S13361-3050NE-04	S13361-3050AE-04	S13361-3050NE-08	S13361-3050AE-08	Unit		
Number of channels	-	16 (4	× 4)	64 (8	-			
Effective photosensitive area/channel	-	3 × 3						
Pixel pitch	-		50					
Number of pixels/channel	-	3584						
Fill factor	-	74						
Package type	-	Surface mount With connector*1		Surface mount	With connector*1	-		
Window	-	Epoxy resin						
Refractive index of window material	-	1.55						

Parameter		Symbol	Value	Unit			
Spectral response range		λ	320 to 900	nm			
Peak sensitivity wavelengt	h	λр	450	nm			
Photon detection efficience	cy (λ=λp)* ⁴	PDE	40	%			
Dark count*5 Ty		CD	0.5	Mcps			
Dark count ¹⁹	Max.	60	1.5	Mcps			
Terminal capacitance		Ct	320	pF			
Gain		M	1.7×10^{6}	-			
Breakdown voltage		VBR	53 ± 5	V			
Recommended operating voltage		Vop	VBR + 3	V			
Vop variation between Typ.			0.1	v			
channels in one product	Max.	-	0.3	v			
Temperature coefficient of recommended operating voltage		ΔTVop	54	mV/°C			

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Back-up: Single SiPM

Selection guide

Type no.	Pixel pitch (µm)	Effective photosensitive area (mm)	Number of pixels	Package	Fill factor (%)
S13360-1325CS		1.3 × 1.3	2668	Ceramic	
S13360-1325PE		1.5 X 1.5	2000	Surface mount type	
S13360-3025CS	25	3.0 × 3.0	14400	Ceramic	47
S13360-3025PE	25	3.0 × 3.0	14400	Surface mount type	4/
S13360-6025CS		6.0 × 6.0 57600		Ceramic	
S13360-6025PE		0.0 × 0.0	57600	Surface mount type	
S13360-1350CS	50	1.3 x 1.3	667	Ceramic	
S13360-1350PE		1.3 × 1.3	00/	Surface mount type	
S13360-3050CS		3.0 × 3.0	3600	Ceramic	74
S13360-3050PE	50	3.0 × 3.0	3000	Surface mount type	/4
S13360-6050CS		6.0×6.0	14400	Ceramic	
S13360-6050PE		6.0 × 6.0	14400	Surface mount type	
S13360-1375CS		1.3 × 1.3	285	Ceramic	
S13360-1375PE		1.5 × 1.5	285	Surface mount type	
S13360-3075CS	75	20.00	1000	Ceramic	02
S13360-3075PE		3.0 × 3.0	1600	Surface mount type	82
S13360-6075CS		6060		Ceramic	
S13360-6075PE		6.0 × 6.0	6400	Surface mount type	

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Back-up: Single SiPM

Electrical and optical characteristics (Typ. Ta=25 °C, unless otherwise noted)

					Dark o	ount*5						Tem-
Type no.	Measure- ment conditions	Spectral response range λ	Peak sensitivity wavelength λp	Photon detection efficiency PDE* ⁴ λ=λp (%)	Typ.	Max.	Terminal capaci- tance Ct	Gain M	Break- down voltage VBR	Crosstalk probability (%)	Recom- mended operating voltage Vop	perature coefficient at recom- mended operating voltage ∆TVop (mV/°C)
S13360-1325CS		270 to 900	(iiii)	(70)					(•)	(70)	(•)	(IIIV/ C)
S13360-1325PE		320 to 900			70	210	60					
S13360-3025CS	Vover	270 to 900	1	25	400	1200	320	7.0×10^{5}			VBR + 5	
S13360-3025PE	=5 V	320 to 900		25	400	1200	320	7.0 × 10 ³		1	VBR + 5	
S13360-6025CS]	270 to 900			1600	5000 1280	1280					
S13360-6025PE		320 to 900			1000	5000	1200					
S13360-1350CS		270 to 900			90	270	60					
S13360-1350PE		320 to 900										
S13360-3050CS	Vover	270 to 900	450	40	500	1500	320	1.7×10^{6}	53 ± 5	3	VBR + 3	54
S13360-3050PE	=3 V	320 to 900					010		00 - 0	, in the second s		
S13360-6050CS		270 to 900			2000	6000	1280					
S13360-6050PE		320 to 900			2000		1200					
S13360-1375CS		270 to 900 90 270	270	60								
S13360-1375PE	Vover	320 to 900		50	50	2/0	00					
S13360-3075CS		270 to 900			500	1500	320	4.0×10^{6}		7	VBR + 3	
S13360-3075PE		320 to 900			500	1500	520	4.0 × 10°		· /	VOR T J	
S13360-6075CS		270 to 900			2000	6000	1280					
S13360-6075PE	320 to 900	320 to 900			2000	0000	1200					

*4: Photon detection efficiency does not include crosstalk or afterpulses.

*5: Threshold=0.5 p.e.

Note: The above characteristics were measured at the operating voltage that yields the listed gain. (See the data attached to each product.)

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